Eligible EWC/ACHMM Scholarship Applicants must:

- Be an undergraduate or graduate-level student enrolled in a university or college in the Eastern Washington Chapter area (includes portions of Eastern Washington, Eastern Oregon, Idaho and Montana)

OR be an undergraduate or graduate-level student with a parent/grandparent who is a current (2006) member of the EWC/ACHMM

- Be majoring in a science or engineering field with the intent to pursue a career related to hazardous materials management (e.g. environmental science, public health, industrial hygiene, chemical safety, and hazardous waste disposal technology)

- Have a good academic standing

- Submit along with the completed application form (see attached), an essay explaining the applicant’s interest in pursuing a career related to hazardous materials management. This can be substituted with an article discussing a current or emerging issue on hazardous materials management. Application must be received by November 1, 2006. The essay or the article must be at least 100 words, but not more than 200 words.

Evaluation criteria for the application include: essay/article evaluation (approximately 50%); academic standing (approximately 15%); student status (approximately 15%); subjective general evaluation (approximately 20%).

The Eastern Washington Chapter/Academy of Hazardous Materials (EWC/ACHMM) selects students for the scholarship awards based on individual merits using the above criteria, regardless of gender, age, race, religions or political affiliation. Scholarship shall be awarded for payment toward tuition and laboratory-fee only, and shall not be used for non-school related purposes. We, this chapter, reserve the right to award, increase, reduce, or terminate the award or the number of awards based on the chapter’s financial reserves. Current plan is to award one scholarship at $1000 this year with the intent to encourage applicant’s interest in the pursuit of a career in hazardous materials management.

Students interested in applying for this scholarship shall submit a complete application package to the above address by November 1, 2006. Late or incomplete application packages shall not be considered for scholarship award. Application materials submitted will not be returned to the applicant nor will the materials be disclosed to anyone except on a need to know basis. In submitting the application, the applicant acknowledges and agrees that the submitted materials become the property of this chapter and this chapter is given the freedom to retain or dispose of the materials without further notice to the applicant.

For further information or questions regarding this program, please feel free to contact:

Andrea Prignano
509-376-1057 (days)
email: andrea_l_prignano@rl.gov

Jeannette Hyatt
509-376-7923 (days)
email: Jeannette_E_Hyatt@rl.gov